

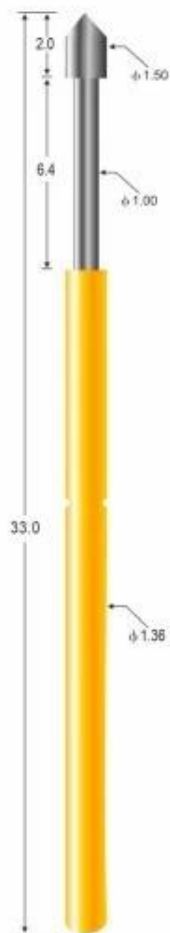


SFENG 1984 PCB



Model	SF-P100
Thickness	1.90mm±.0748"
Surface finish	1.35mm±.0532" 1.40mm±.0551"
Plating	6.3±.2481"
Temperature	120°
Material	Be Cu,Rh Copper Nickel
Current	3A
Power	50W
Time	100h
Weight	700g



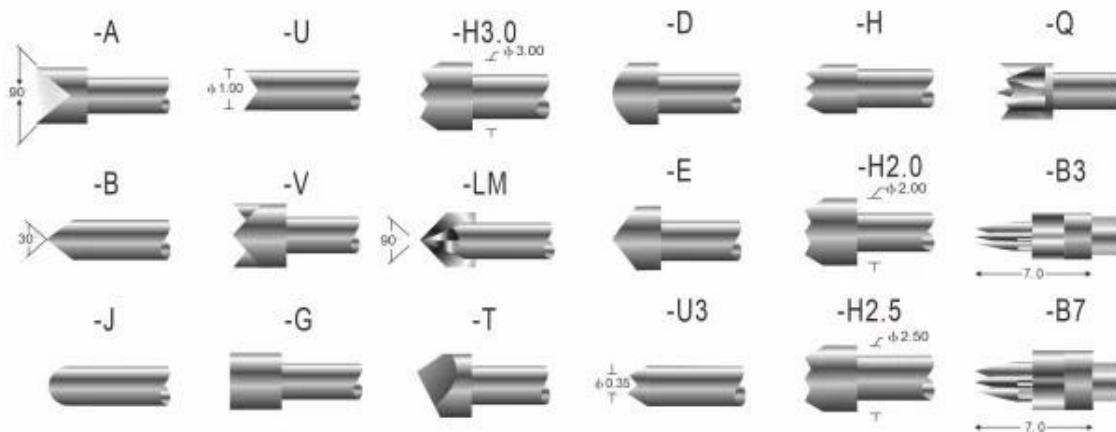


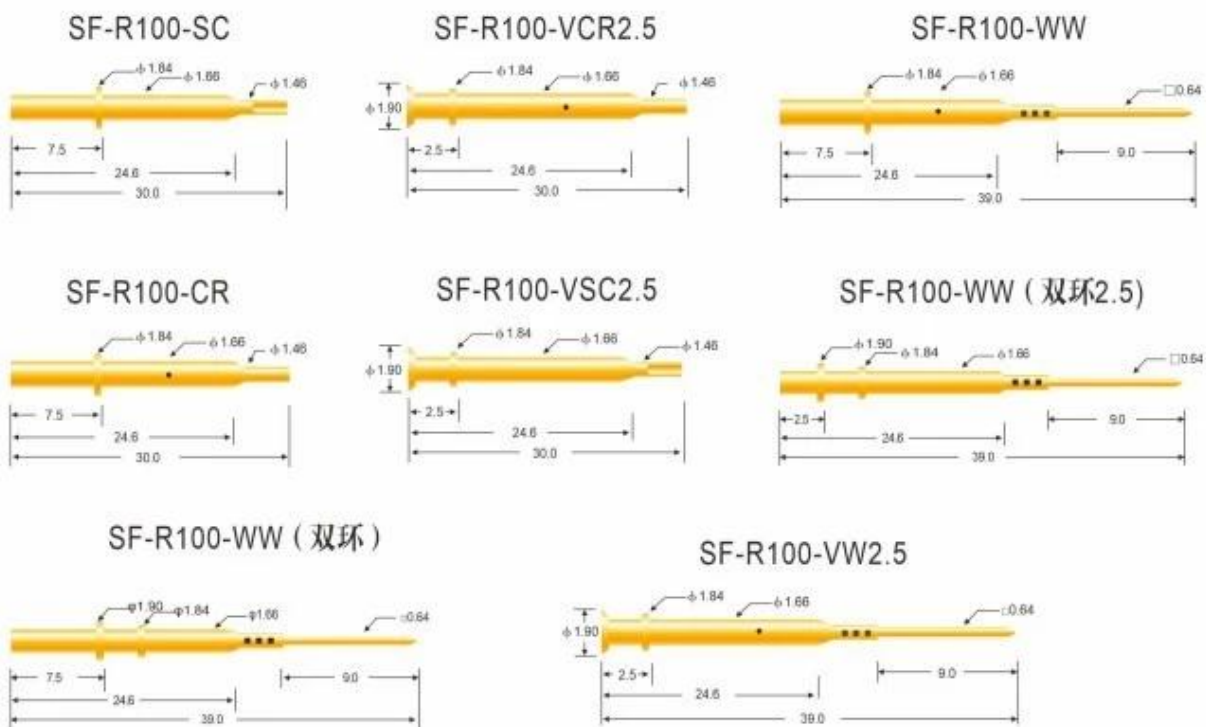
SF-P100-E

技术规格 PROBE SPECIFICATIONS

Recommended minimum center 最小间距	1.90mm(.0748 ")
Mounting hole size 钻孔尺寸	压克力: 1.35mm(.0532 ") 电木板、玻璃纤维板: 1.40mm(.0551 ")
Full travel 行程	6.3(.2481 ")
Spring force 弹簧压力	120g(克)
Materials and finishes 材料及涂饰	Plunger:SK4, Ni or Au plated BeCu, Ni or Au plated Phosphor bronze, Ni or Au plated Barrel:Phosphor bronze, Au plated Spring:Stainless steel
Current ration 额定电流	3A(安培)
Contact resistance 接触电阻	50mΩ(毫欧姆)

Receptacle specifications
Materials and finishes: Phosphor bronze,Gold plated





技术规格 PROBE SPECIFICATIONS

Recommended minimum center 最小间距	2.54mm(.1000 ")
Mounting hole size 钻孔尺寸	压克力: 1.70mm(.0670 ") 电木板、玻璃纤维板: 1.75mm(.0689 ")
Materials and finishes 材料及涂饰	Barrel: Brass, Gold plated
Connections 接线形式	Crimp: R100-VCR2.5, R100-CR Solder cup: R100-VSC2.5, R100-SC Wire wrap: R100-VW2.5, R100-WW, R100-WW(双环2.5), R100-WW(双环)

Receptacle specifications
Materials and finishes: Phosphor bronze, Gold plated



1. 24-pin probe
2. OEM
3. 24-pin probe
4. 24-pin probe



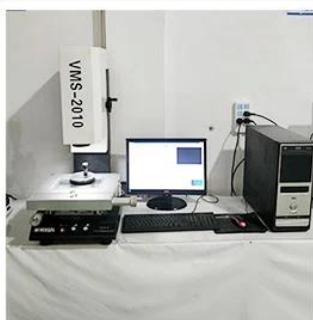
3. BGA

5.

7. 30#OK POM



6. Packing



□□□□ DHL□UPS□FedEx□TNT□EMS □□□

Exwork FOB CNF CIF



Q1. 請說明

A1: 請說明

Q2. 請說明

A2: 請說明QC

Q3. 請說明

A3: 請說明

Q4. 請說明

A4: 請說明

Q5. 請說明

